

Electronic Patent Application Fee Transmittal

Application Number:	10522413			
Filing Date:	26-Jan-2005			
Title of Invention:	METHOD OF FABRICATING SOI WAFER			
First Named Inventor/Applicant Name:	Hiroji Aga			
Filer:	Christopher W. Brown/Roberta Vahey			
Attorney Docket Number:	121797			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Claims:				
Miscellaneous-Filing:				
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Patent-Appeals-and-Interference:				
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Utility Appl issue fee	1501	1	1440	1440
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Total in USD (\$)				1740